1 Characteristics

Symbol	Parameters	Value	Unit		
I	DMC on state surrant (180° conduction angle)	BTA40, BTA41	T _c = 80 °C	40	
T(RMS)	I _{T(RMS)} RMS on-state current (180° conduction angle)		T _c = 95 °C	40	A
	Non repetitive surge peak on state surrent (full ave	$a_{\rm c}$ T initial = 25 °C	t _p = 16,7 ms	420	^
ITSM	Non repetitive surge peak on-state current (full cycl	e, r_j milar – 25 C)	t _p = 20 ms	400	A
l ² t	l ² t value for fusing	t _p = 10 ms		1000	A ² s
dl/dt	Critical rate of rise of on-state current I_G = 2 x I_{GT} , $t_r \le 100$ ns	f = 120 Hz	T _j = 125 °C	50	A/µs
V_{DSM}, V_{RSM}	Non repetitive surge peak off-state voltage	t _p = 20 ms	T _j = 25 °C	V _{DRM} , V _{RRM} + 100	V
I _{GM}	Peak gate current	t _p = 20 μs	T _j = 125 °C	8	Α
P _{G(AV)}	Average gate power dissipation	1	W		
T _{stg}	Storage junction temperature range	-40 to +150	°C		
Тј	Operating junction temperature range		-40 to +125	°C	

Table 1. Absolute maximum ratings

Table 2. Electrical characteristics (T_j = 25 °C, unless otherwise specified) - standard (4 quadrants)

Symbol	Parameters	Quadrant		Values	Unit
I _{GT} ⁽¹⁾		1 - 11 - 111	Max.	50	mA
IGT. /	V_D = 12 V, R_L = 33 Ω	IV	IVIAX.	100	
V _{GT}		1 - 11 - 111	Max.	1.3	V
V _{GD}	V_D = V_{DRM} , R_L = 3.3 k Ω , T_j = 125 °C	1 - 11 - 111	Min.	0.2	V
I _H ⁽²⁾	I _T = 500 mA		Max.	80	mA
IL.	I _G = 1.2 I _{GT}	I - III - IV	Max.	70	mA
<u>ц</u>			Max.	160	IIIA
dV/dt ⁽²⁾	V_D = 67 % V_{DRM} gate open, T_j = 125 °C	Min.	500	V/µs	
(dV/dt)c ⁽²⁾	$(dI/dt)c = 20 \text{ A/ms}, T_j = 125 \text{ °C}$		Min.	10	V/µs

1. Minimum I_{GT} is guaranteed at 5 % of I_{GT} max.

2. For both polarities of A2 referenced to A1

Table 3. Static electrical characteristics

Symbol	Test conditions	Тj		Value	Unit
V _{TM} ⁽¹⁾	I _{TM} = 60 A, t _p = 380 μs	25 °C	Max.	1.55	V
V _{TO} ⁽¹⁾	threshold on-state voltage	125 °C	Max.	0.85	V
R _D ⁽¹⁾	Dynamic resistance	125 °C	Max.	10	mΩ
I _{DRM} /I _{RRM}	$V_{T} = V_{DRM}, V_{T} = V_{RRM}$	25 °C	Max.	5	μA
	VI - VDRM, VI - VRRM	125 °C	IVIAA.	5	mA

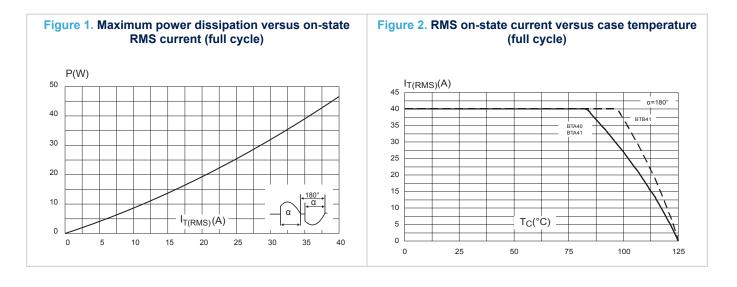
1. For both polarities of A2 referenced to A1

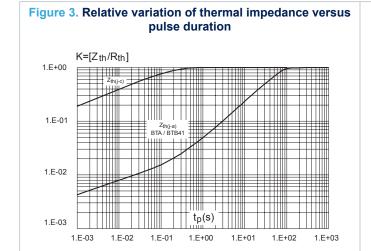
Table 4. Thermal resistance

Symbol	Parameters			Unit
P	lupation to appa (AC)	BTA40 / BTA41	0.9	°C/W
R _{th(j-c)}	Junction to case (AC)	BTB41	0.6	
R _{th(j-a)}	Junction to ambient	BTA40 / BTA41 / BTB41	50	



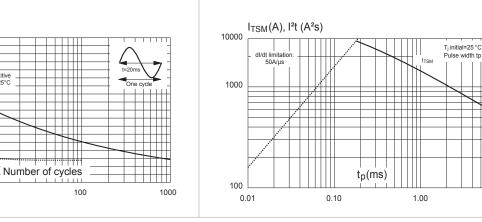
1.1 **Characteristics (curves)**











sinusoidal pulse

ITSM (A)

10

450

400

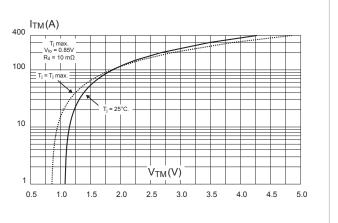
350

0

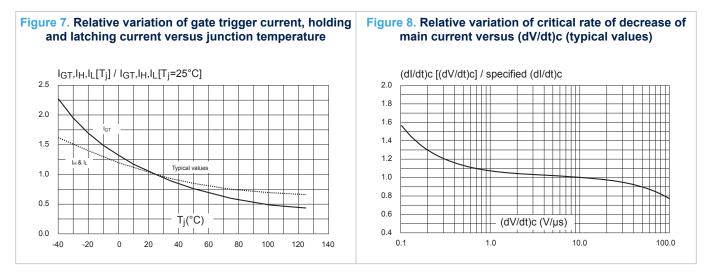
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10.00

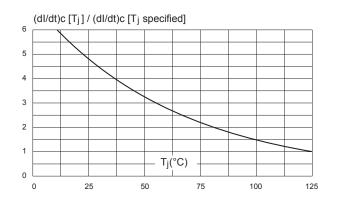
Figure 4. On-state characteristics (maximum values)











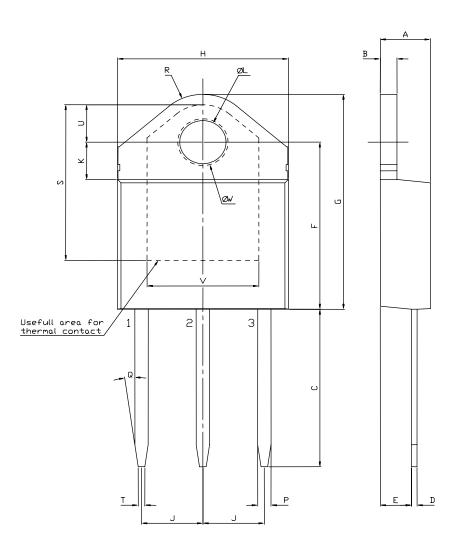
2 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK packages, depending on their level of environmental compliance. ECOPACK specifications, grade definitions and product status are available at: www.st.com. ECOPACK is an ST trademark.

2.1 TOP3 insulated and non-insulated package information

- Epoxy meets UL94, V0
- Lead-free packages
- Recommended torque: 1.05 N·m (max. torque: 1.2 N·m)

Figure 10. TOP3 insulated and non-insulated package outline



			[Dimensions			
Ref.		mm			Inches ⁽¹⁾		
	Min.	Тур.	Max.	Min.	Тур.	Max.	
А	4.40		4.60	0.1732		0.1812	
В	1.45		1.55	0.0570		0.0611	
С	14.35		15.60	0.5649		0.6142	
D	0.50		0.70	0.0196		0.0276	
E	2.70		2.90	0.1062		0.1142	
F	15.80		16.50	0.6220		0.6497	
G	20.40		21.10	0.8031		0.8308	
Н	15.10		15.50	0.5944		0.6103	
J	5.40		5.65	0.2125		0.2225	
К	3.40		3.65	0.1338		0.1438	
L	4.08		4.17	0.1606		0.1642	
М	1.20		1.40	0.0472		0.0552	
R		4.60			0.1811		

Table 5. TOP3 insulated and non-insulated mechanical data

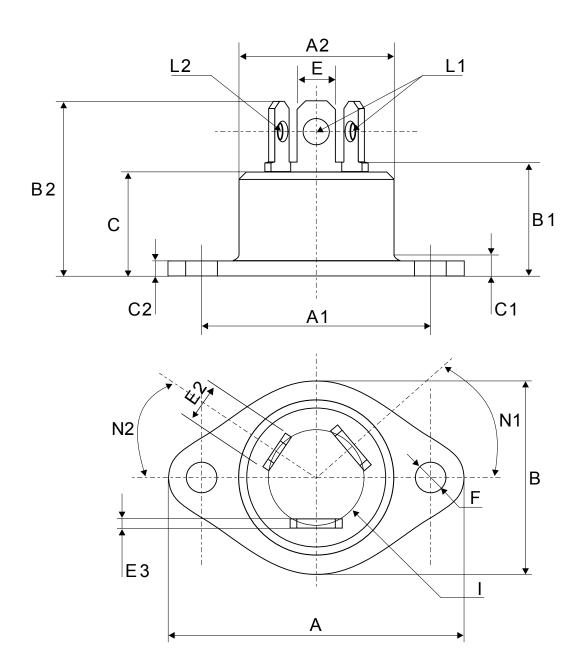
1. Inches given for reference only

2.2 RD91 package information

57

- Epoxy meets UL94, V0
- Cooling method: Conduction
- Recommended torque: 0.9 to 1.2 N·m

Figure 11. RD91 package outline



	Dimensions						
Ref.	mm			Inches ⁽¹⁾			
	Min.	Тур.	Max.	Min.	Тур.	Max.	
А			40.00			1.575	
A1	30.10		30.30	1.185		1.193	
A2			22.00			0.867	
В			27.00			1.063	
B1	13.50		16.50	0.531		0.650	
B2			24.00			0.945	
С			14.00			0.552	
C1			3.50			0.138	
C2	1.90		2.10	0.074		0.083	
E	6.10		6.50	0.240		0.256	
E2	4.80		5.20	0.188		0.205	
E3	0.70		0.90	0.027		0.036	
F	4.00		4.30	0.157		0.170	
I	11.20		11.60	0.440		0.536	
L1	3.10		3.50	0.122		0.138	
L2	1.70		1.90	0.066		0.075	
N1	33°		43°	33°		43°	
N2	28°		38°	28°		38°	

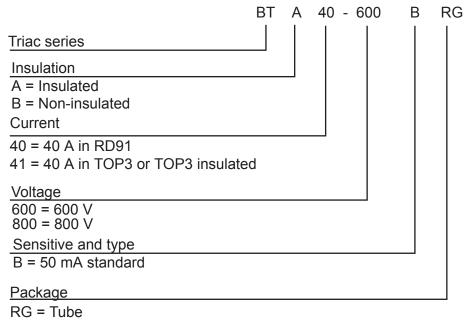
Table 6. RD91 mechanical data

1. Inches given for reference only

3 Ordering information

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Figure 12. Ordering information scheme (BTA40, BTA41 and BTB-41 series)



Blank = Bulk

Table 7. Ordering information

Order code	Marking	Package	Weight	Base qty.	Delivery mode
BTA40-600B	BTA40600B	RD91	20 g	25	Bulk
BTA40-800B	BTA40800B	RD91	20 g	25	Bulk
BTA41-600BRG	BTA41600B	TOP3 Ins.	4.5 g	30	Tube
BTA41-800BRG	BTA41800B	TOP3 Ins.	4.5 g	30	Tube
BTB41-600BRG	BTB41600B	TOP3	4.5 g	30	Tube
BTB41-800BRG	BTB41800B	TOP3	4.5 g	30	Tube

Revision history

Date	Revision	Changes
Sep-2003	5	Last update.
25-Mar-2005	6	TOP3 delivery mode changed from bulk to tube.
14-Oct-2005	7	$\rm T_{c}$ values for $\rm I_{T}$ changed in Table 3. ECOPACK statement added.
10-Aug-2009	8	Updated Table 2 to correctly place packages. Updated Figure 2. Table 5 changed to correctly place TOP3. Updated ECOPACK statement.
02-Dec-2020	9	Updated Figure 6 and Figure 12. Added Application section. Minor text change.
28-Jan-2021	10	Updated Table 1 and Table 4.
24-Mar-2021	11	Updated coverimage.

Table 8. Document revision history

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